



RF360
Europe GmbH

SAW components

SAW duplexer

Automotive telematics
LTE band 3

Series/type:	B4421
Ordering code:	B39182B4421P810
Date:	February 26, 2018
Version:	2.2

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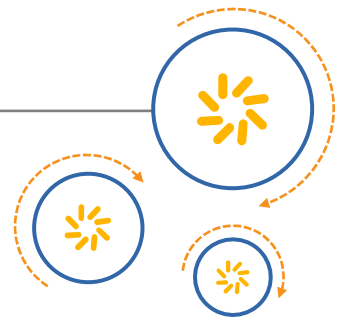
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A Qualcomm – TDK Joint Venture

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SAW components	B4421
SAW duplexer	1747.5 / 1842.5 MHz

Data sheet

Table of contents

1 Application	4
2 Features	4
3 Package	5
4 Pin configuration	5
5 Matching circuit	6
6 Characteristics	7
7 Maximum ratings	10
8 Transmission coefficients	11
9 Reflection coefficients	14
10 Packing material	15
11 Marking	18
12 Soldering profile	19
13 Annotations	20
14 Cautions and warnings	21
Important notes	22

Data sheet

1 Application

- Low-loss SAW duplexer for band 3 systems
- Low insertion attenuation
- Low amplitude ripple
- High isolation between Tx and Rx

2 Features

- Package size 1.8 ± 0.1 mm \times 1.4 ± 0.1 mm
- Package height 0.45 mm (max.)
- Approximate weight 4 mg
- RoHS compatible
- Package for Surface Mount Technology (SMT)
- Ni/Au-plated terminals
- Filter surface passivated
- Electrostatic Sensitive Device (ESD)
- Moisture Sensitivity Level 2a (MSL2a)
- AEC-Q200 qualified component family (Grade 3: -40 °C to $+85$ °C)

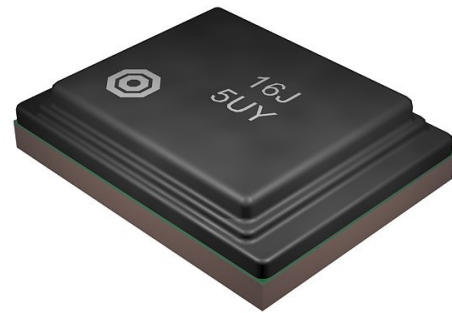


Figure 1: Picture of component with example of product marking.

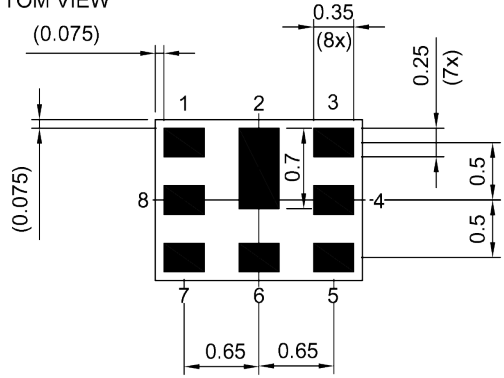
SAW components **B4421**

SAW duplexer **1747.5 / 1842.5 MHz**

Data sheet

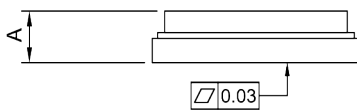
3 Package

BOTTOM VIEW

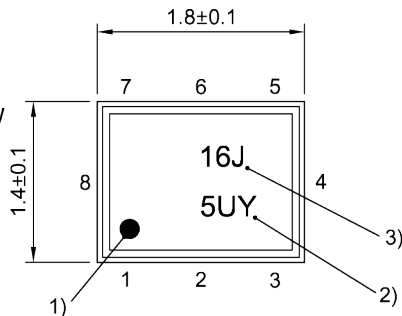


Pad and Pitch Tolerance ±0.05

SIDE VIEW

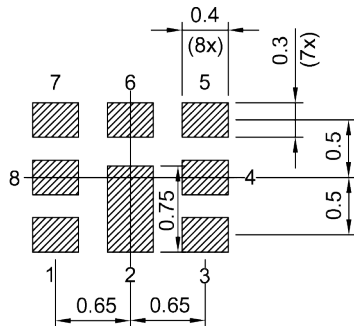


TOP VIEW



- 1) Marking for pad number 1
- 2) Example of encoded lot number
- 3) Example of encoded filter type number

Land pattern THRU VIEW



Landing pad tolerance -0.02

Figure 2: Drawing of package with package height A = 0.45 mm (max.). See Sec. Package information (p. 21).

4 Pin configuration

- 1 RX
- 3 TX
- 6 ANT
- 2, 4, 5, 7, 8 Ground

Data sheet

5 Matching circuit

$$\blacksquare L_{p6} = 3.1 \text{ nH}$$

$$\blacksquare L_{s3} = 1.8 \text{ nH}$$

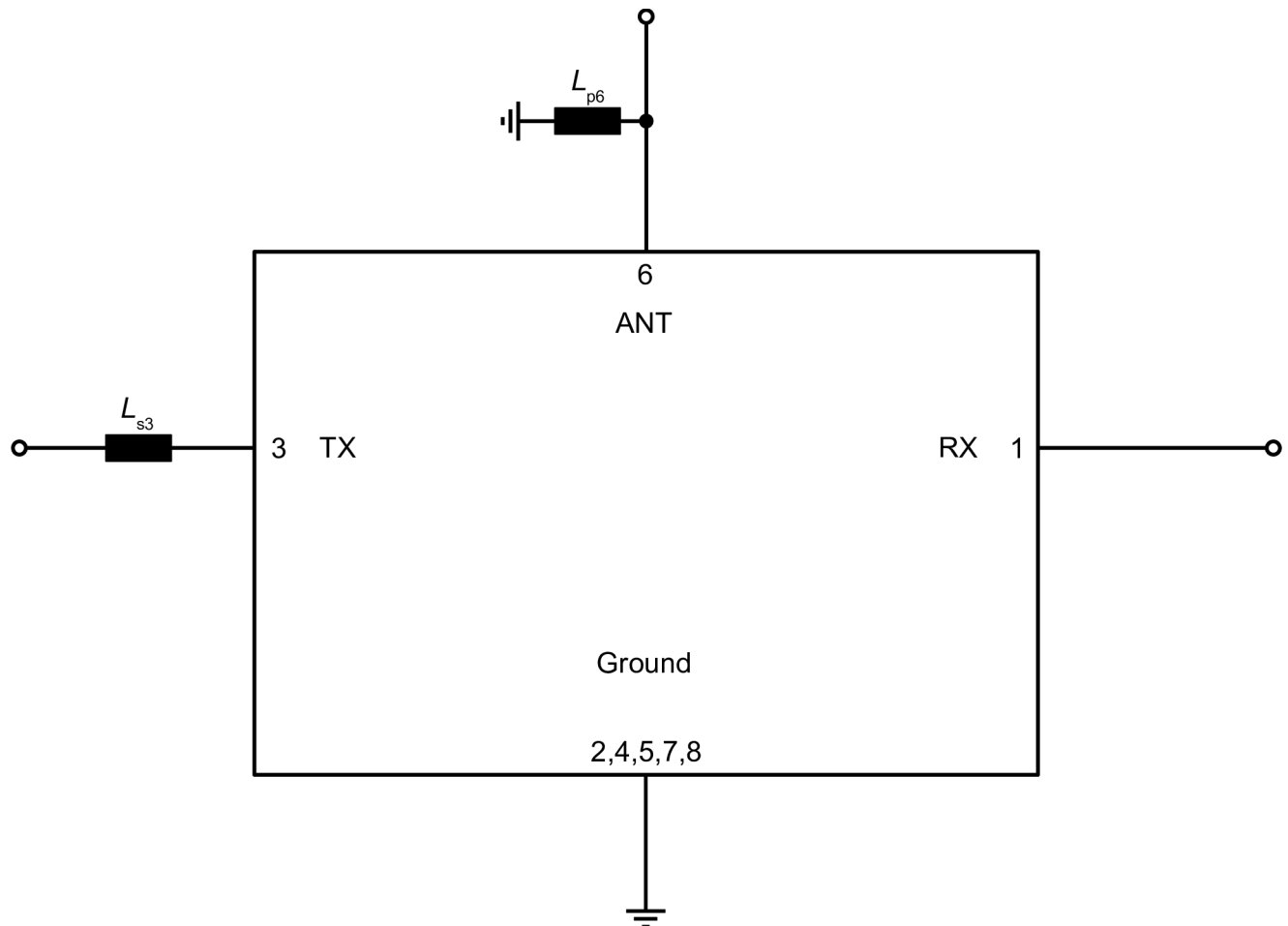


Figure 3: Schematic of matching circuit.

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B4421

SAW duplexer

1747.5 / 1842.5 MHz

Data sheet

6 Characteristics

6.1 TX – ANT

Temperature range for specification	T_{SPEC}	= -30 °C ... +85 °C
TX terminating impedance	Z_{TX}	= 50 Ω with ser. 1.8 nH ¹⁾
ANT terminating impedance	Z_{ANT}	= 50 Ω with par. 3.1 nH ¹⁾
RX terminating impedance	Z_{RX}	= 50 Ω

Characteristics TX – ANT				min. for T_{SPEC}	typ. @ +25 °C	max. for T_{SPEC}	
Center frequency			f_C	—	1747.5	—	MHz
Maximum insertion attenuation							
	1710... 1785	MHz	$\alpha_{INT,max}^{2)}$	—	2.2	2.8 ³⁾	dB
	1710... 1785	MHz	$\alpha_{INT,max}^{2)}$	—	2.2	3.2	dB
	1710.24... 1784.76	MHz	α_{max}	—	2.4	4.4	dB
Amplitude ripple (p-p)			$\Delta\alpha_{INT}^{2)}$				
	1710... 1785	MHz		—	1.2	2.5	dB
Maximum VSWR			VSWR _{max}				
@ TX port	1710.24... 1784.76	MHz		—	1.8	2.0	
@ ANT port	1710.24... 1784.76	MHz		—	1.7	2.0	
Minimum attenuation							
	100... 1565.42	MHz	α_{min}	32	36	—	dB
	703... 756	MHz	α_{min}	40	45	—	dB
	814... 915	MHz	α_{min}	36	42	—	dB
	925... 960	MHz	α_{min}	36	41	—	dB
	1559... 1605.886	MHz	α_{min}	34	43	—	dB
	1605.886... 1680	MHz	α_{min}	30	35	—	dB
	1805... 1880	MHz	$\alpha_{INT,min}^{2)}$	45 ³⁾	49	—	dB
	1805... 1880	MHz	$\alpha_{INT,min}^{2)}$	42	49	—	dB
	1805.24... 1879.76	MHz	α_{min}	35	48	—	dB
	1920... 1980	MHz	α_{min}	30	38	—	dB
	2110... 2170	MHz	α_{min}	35	41	—	dB
	2400... 2500	MHz	α_{min}	35	40	—	dB
	2500... 2570	MHz	α_{min}	35	41	—	dB
	2620... 2690	MHz	α_{min}	35	38	—	dB
	3420... 3570	MHz	α_{min}	25	32	—	dB
	4900... 6000	MHz	α_{min}	15	25	—	dB

¹⁾ See Sec. Matching circuit (p. 6).

²⁾ Integrated attenuation α_{INT} : Averaged power $|S_{ij}|^2$ over the center 4.5 MHz of LTE 5 MHz (25 RB) channels.

³⁾ Valid for temperature $T = -10$ °C...+55 °C.

SAW components

B4421

SAW duplexer

1747.5 / 1842.5 MHz

Data sheet

6.2 ANT – RX

Temperature range for specification	T_{SPEC}	= -30 °C ... +85 °C
TX terminating impedance	Z_{TX}	= 50 Ω with ser. 1.8 nH ¹⁾
ANT terminating impedance	Z_{ANT}	= 50 Ω with par. 3.1 nH ¹⁾
RX terminating impedance	Z_{RX}	= 50 Ω

Characteristics ANT – RX				min. for T_{SPEC}	typ. @ +25 °C	max. for T_{SPEC}	
Center frequency			f_C	—	1842.5	—	MHz
Maximum insertion attenuation							
	1805... 1880	MHz	$\alpha_{INT,max}^{2)}$	—	2.4	3.1 ³⁾	dB
	1805... 1880	MHz	$\alpha_{INT,max}^{2)}$	—	2.4	3.5	dB
	1805.24... 1879.76	MHz	α_{max}	—	2.6	4.8	dB
Amplitude ripple (p-p)			$\Delta\alpha_{INT}^{2)}$				
	1805... 1880	MHz		—	1.0	2.7	dB
Maximum VSWR			VSWR _{max}				
@ ANT port	1805.24... 1879.76	MHz		—	1.7	2.1	
@ RX port	1805.24... 1879.76	MHz		—	1.7	2.1	
Minimum attenuation							
	95	MHz	α_{min}	50	70	—	dB
	100... 1710	MHz	α_{min}	40	46	—	dB
	1710... 1785	MHz	$\alpha_{INT,min}^{2)}$	45	54	—	dB
	1710.24... 1784.76	MHz	α_{min}	40	51	—	dB
	1785... 1790	MHz	α_{min}	10	38	—	dB
	1920... 1940	MHz	α_{min}	28	38	—	dB
	1940... 2400	MHz	α_{min}	35	44	—	dB
	2400... 2500	MHz	α_{min}	40	45	—	dB
	2500... 2570	MHz	α_{min}	40	44	—	dB
	2570... 3515	MHz	α_{min}	35	44	—	dB
	3515... 3665	MHz	α_{min}	35	47	—	dB
	3665... 3760	MHz	α_{min}	35	46	—	dB
	3760... 6000	MHz	α_{min}	30	39	—	dB

¹⁾ See Sec. Matching circuit (p. 6).

²⁾ Integrated attenuation α_{INT} : Averaged power $|S_{ij}|^2$ over the center 4.5 MHz of LTE 5 MHz (25 RB) channels.

³⁾ Valid for temperature $T = -10$ °C...+55 °C.

SAW components

B4421

SAW duplexer

1747.5 / 1842.5 MHz

Data sheet

6.3 TX – RX

Temperature range for specification	T_{SPEC}	= -30 °C ... +85 °C
TX terminating impedance	Z_{TX}	= 50 Ω with ser. 1.8 nH ¹⁾
ANT terminating impedance	Z_{ANT}	= 50 Ω with par. 3.1 nH ¹⁾
RX terminating impedance	Z_{RX}	= 50 Ω

Characteristics TX – RX				min. for T_{SPEC}	typ. @ +25 °C	max. for T_{SPEC}	
Minimum isolation							
	1710... 1785	MHz	$\alpha_{INT,min}^{2)}$	50	57	—	dB
	1710.24... 1784.76	MHz	α_{min}	42	56	—	dB
	1805... 1880	MHz	$\alpha_{INT,min}^{2)}$	48	52	—	dB
	1805.24... 1879.76	MHz	α_{min}	40	52	—	dB

¹⁾ See Sec. Matching circuit (p. 6).

²⁾ Integrated attenuation α_{INT} : Averaged power $|S_{ij}|^2$ over the center 4.5 MHz of LTE 5 MHz (25 RB) channels.

SAW components

B4421

SAW duplexer

1747.5 / 1842.5 MHz

Data sheet

7 Maximum ratings

Operable temperature	$T_{OP} = -40\text{ °C} \dots +85\text{ °C}$	
Storage temperature	$T_{STG}^{1)} = -40\text{ °C} \dots +85\text{ °C}$	
DC voltage	$ V_{DC} ^{2)} = 0\text{ V}$	
Input power	P_{IN}	
@ TX port: 1710 ... 1785 MHz	28 dBm	Continuous wave for 5000 h @ 50 °C.
@ TX port: 1710 ... 1785 MHz	28 dBm	5 MHz LTE uplink signal (25 RB) for 5000 h @ 50 °C.

¹⁾ Not valid for packaging material. Storage temperature for packaging material is -25 °C to +40 °C.

²⁾ In case of applied DC voltage blocking capacitors are mandatory.

SAW components	B4421
SAW duplexer	1747.5 / 1842.5 MHz

Data sheet

8 Transmission coefficients

8.1 TX – ANT

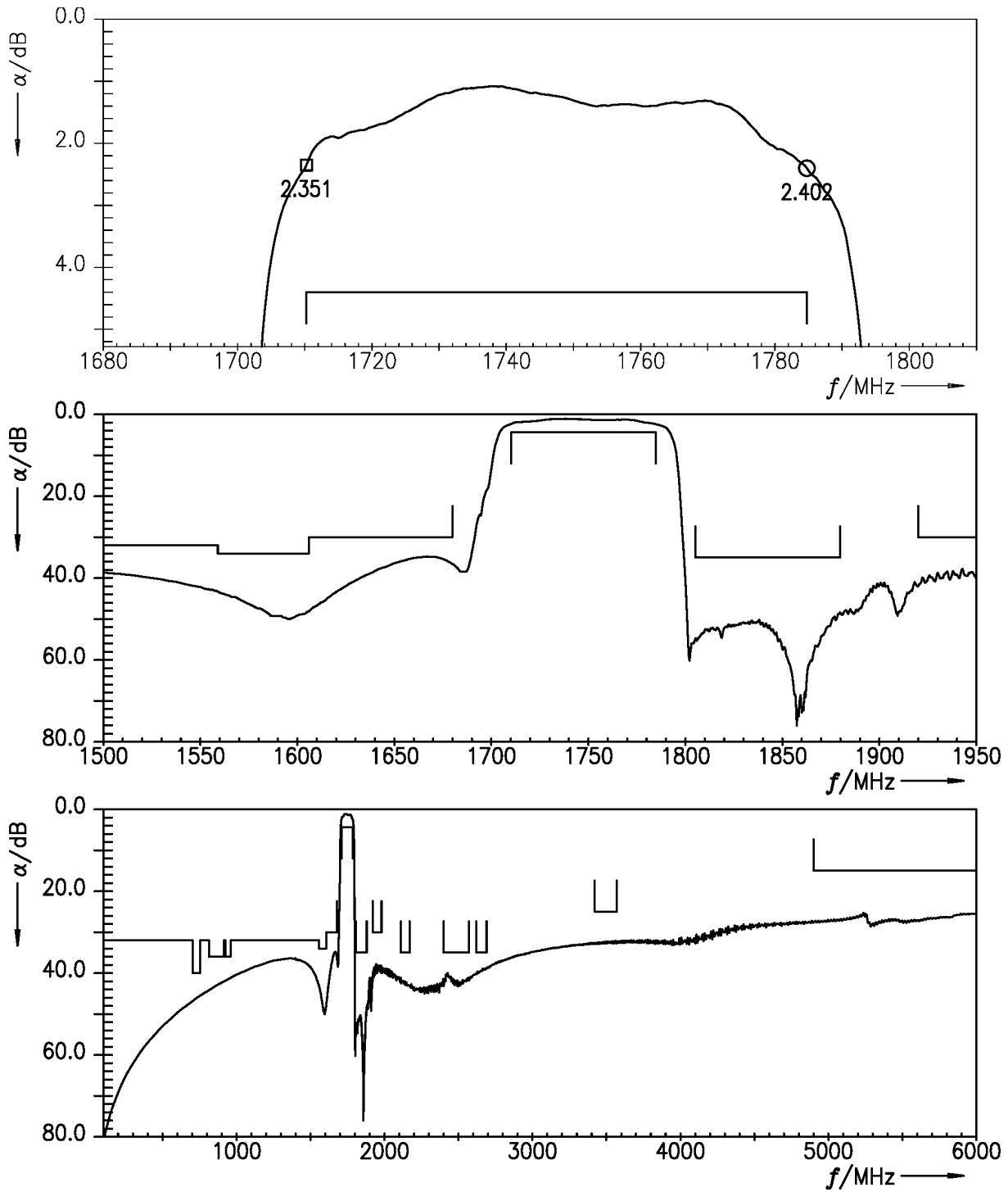


Figure 4: Attenuation TX – ANT.

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SAW duplexer	1747.5 / 1842.5 MHz

Data sheet

8.2 ANT – RX

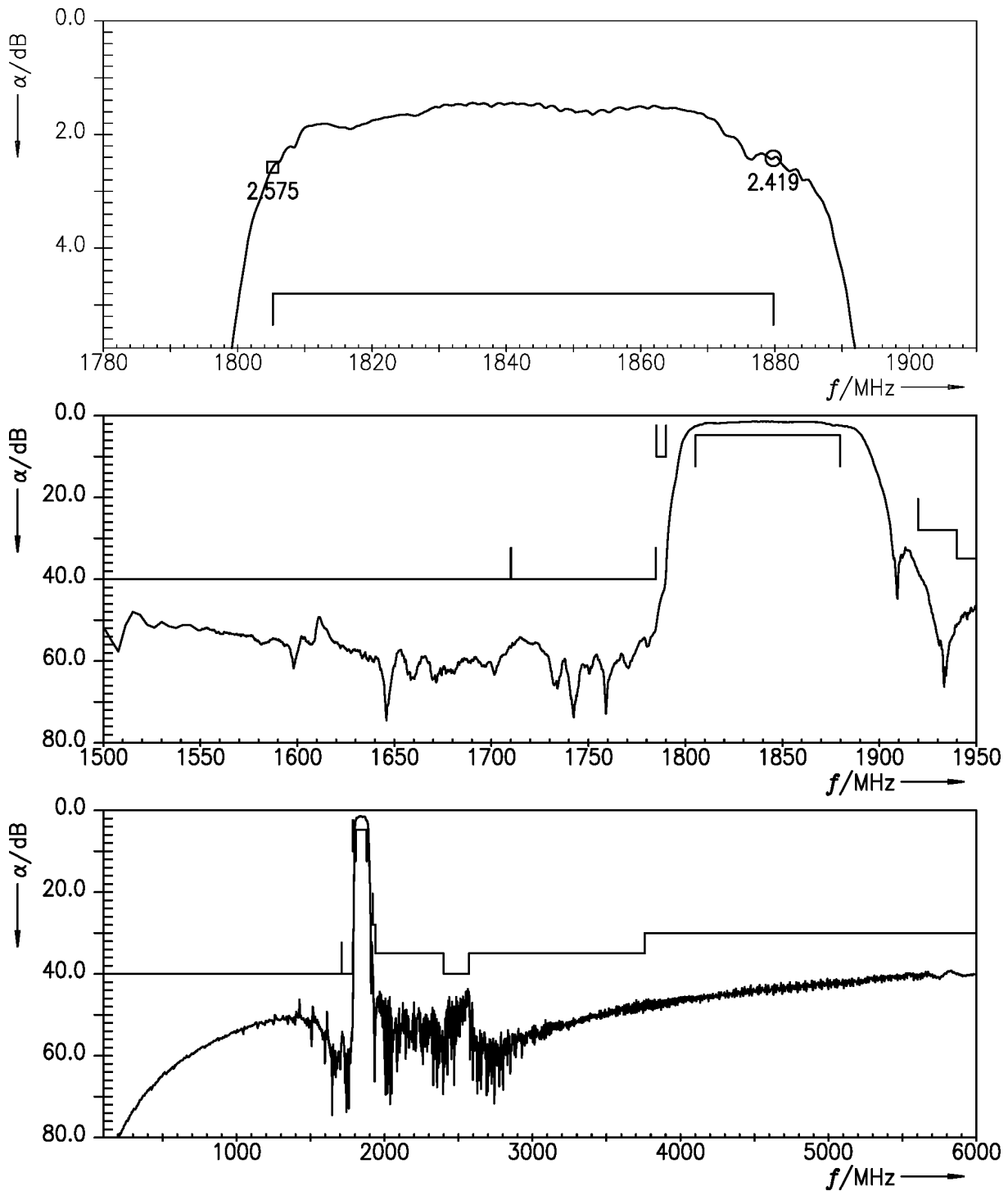


Figure 5: Attenuation ANT – RX.

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SAW duplexer	1747.5 / 1842.5 MHz

Data sheet

8.3 TX – RX

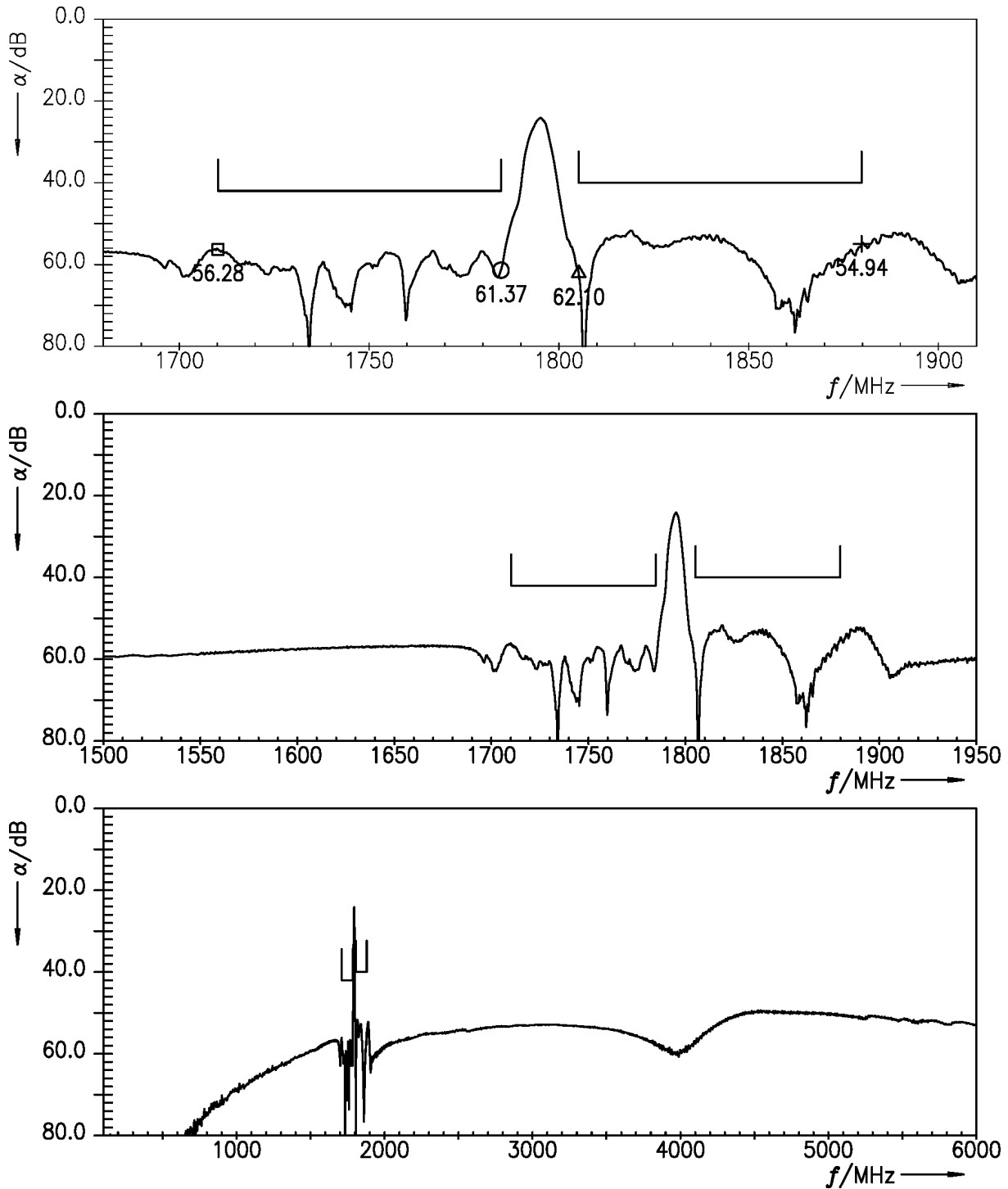


Figure 6: Isolation TX – RX.

Data sheet

9 Reflection coefficients

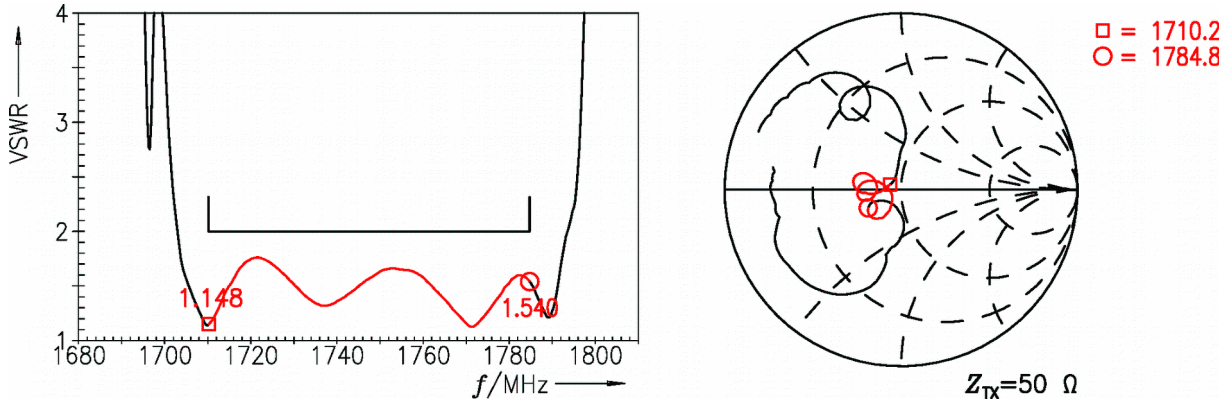


Figure 7: Reflection coefficient at TX port.

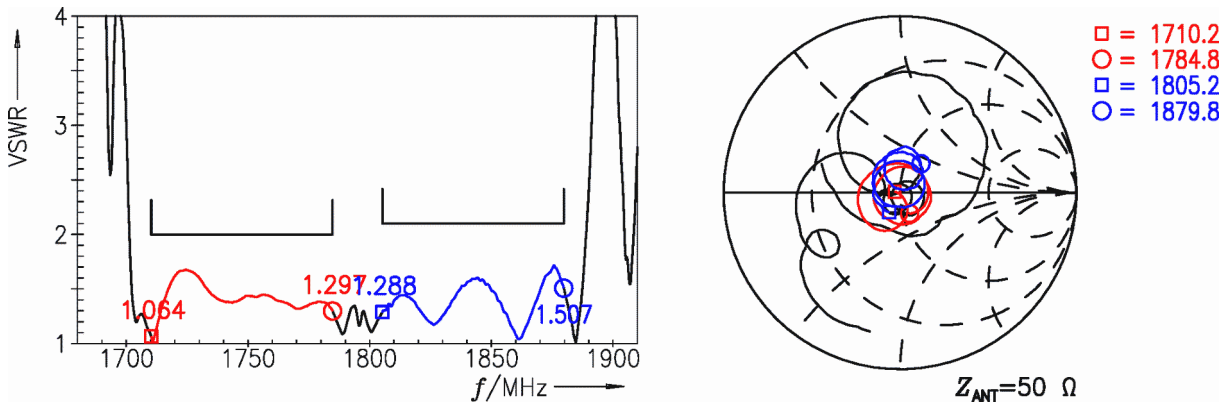


Figure 8: Reflection coefficient at ANT port.

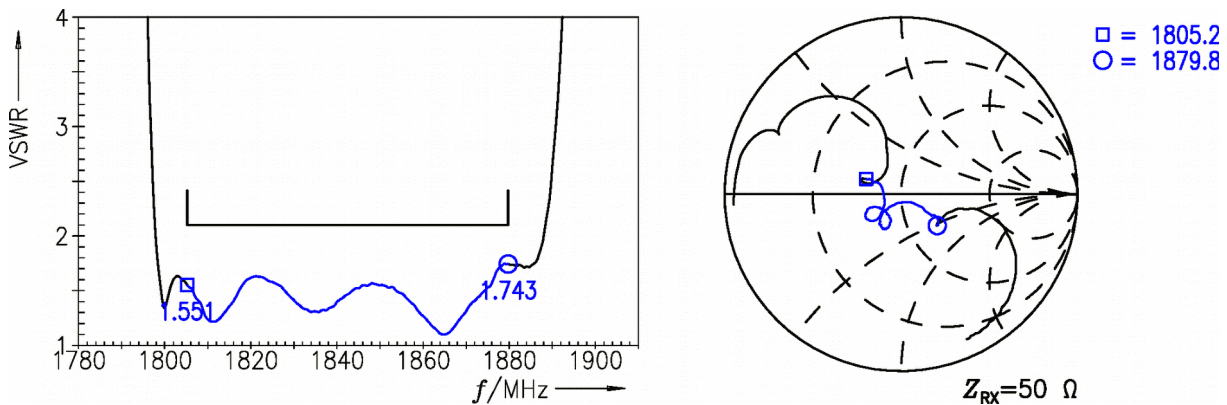


Figure 9: Reflection coefficient at RX port.

SAW components **B4421**
SAW duplexer **1747.5 / 1842.5 MHz**

Data sheet

10 Packing material

10.1 Tape

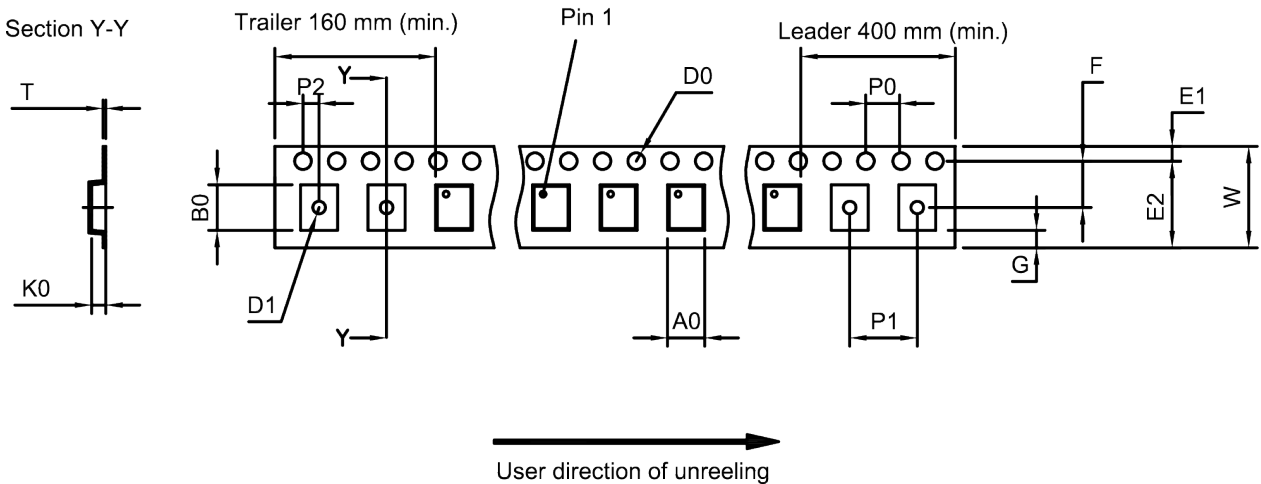


Figure 10: Drawing of tape (first-angle projection) with tape dimensions according to Table 1.

A ₀	1.62±0.05 mm	E ₂	6.25 mm (min.)	P ₁	4.0±0.1 mm
B ₀	2.04±0.05 mm	F	3.5±0.05 mm	P ₂	2.0±0.05 mm
D ₀	1.5+0.1/-0 mm	G	0.75 mm (min.)	T	0.25±0.05 mm
D ₁	0.8±0.05 mm	K ₀	0.62±0.05 mm	W	8.0±0.1 mm
E ₁	1.75±0.1 mm	P ₀	4.0±0.1 mm		

Table 1: Tape dimensions.

SAW components	B4421
SAW duplexer	1747.5 / 1842.5 MHz

Data sheet

10.2 Reel with diameter of 180 mm

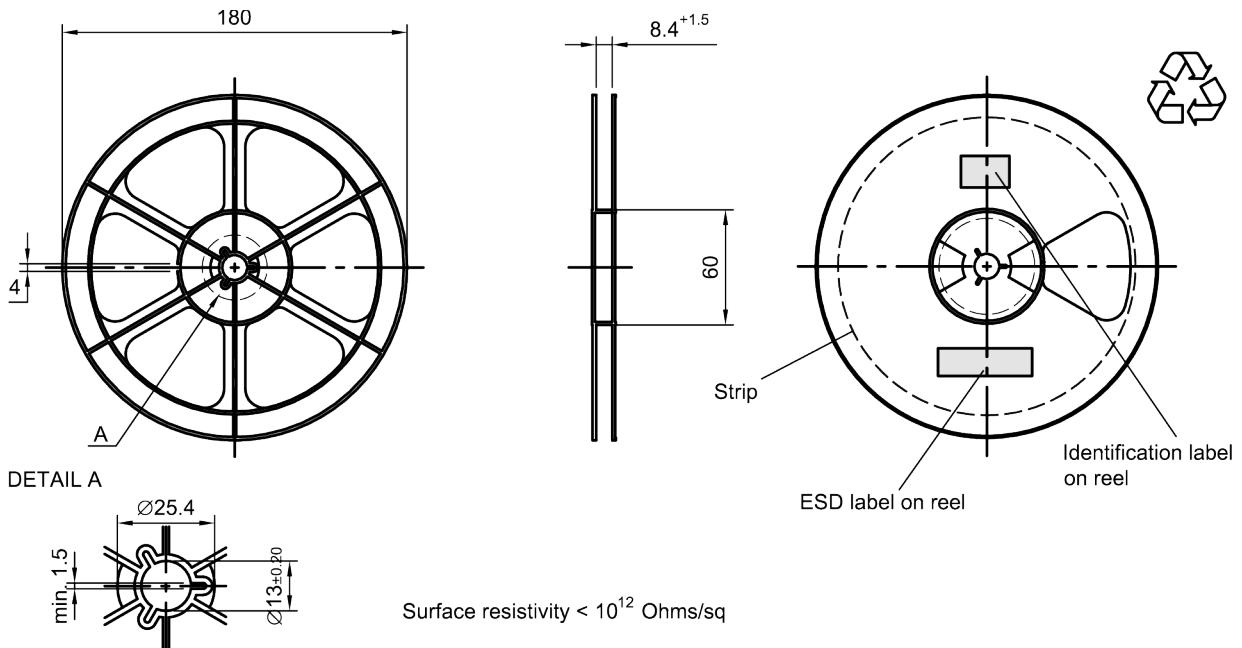


Figure 11: Drawing of reel (first-angle projection) with diameter of 180 mm.

Dimensions [mm]

X = 220+5

Y = 235+5

Sealing area 10±3

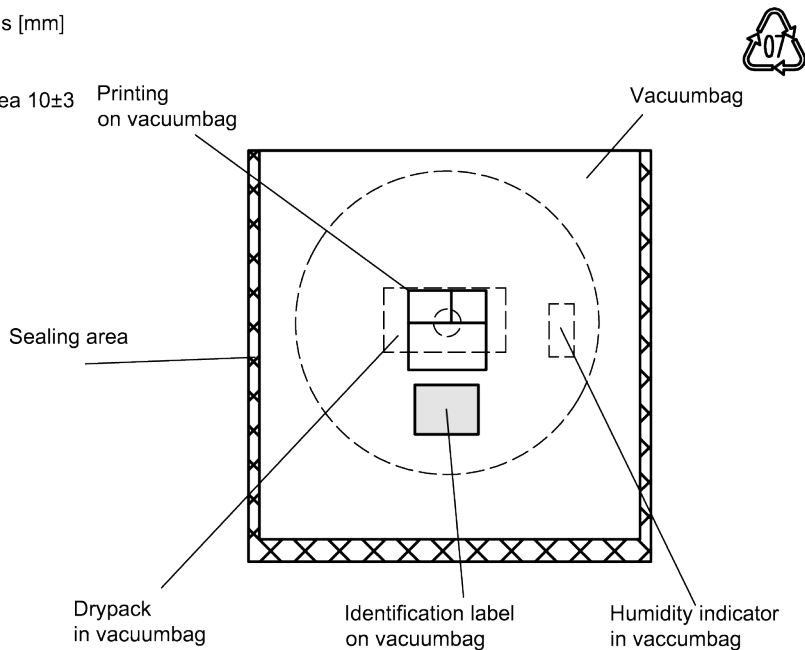


Figure 12: Drawing of moisture barrier bag (MBB) for reel with diameter of 180 mm.

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Data sheet

Dimensions [mm]
 L = 188
 B = 188
 H = 30
 Tolerance ±5

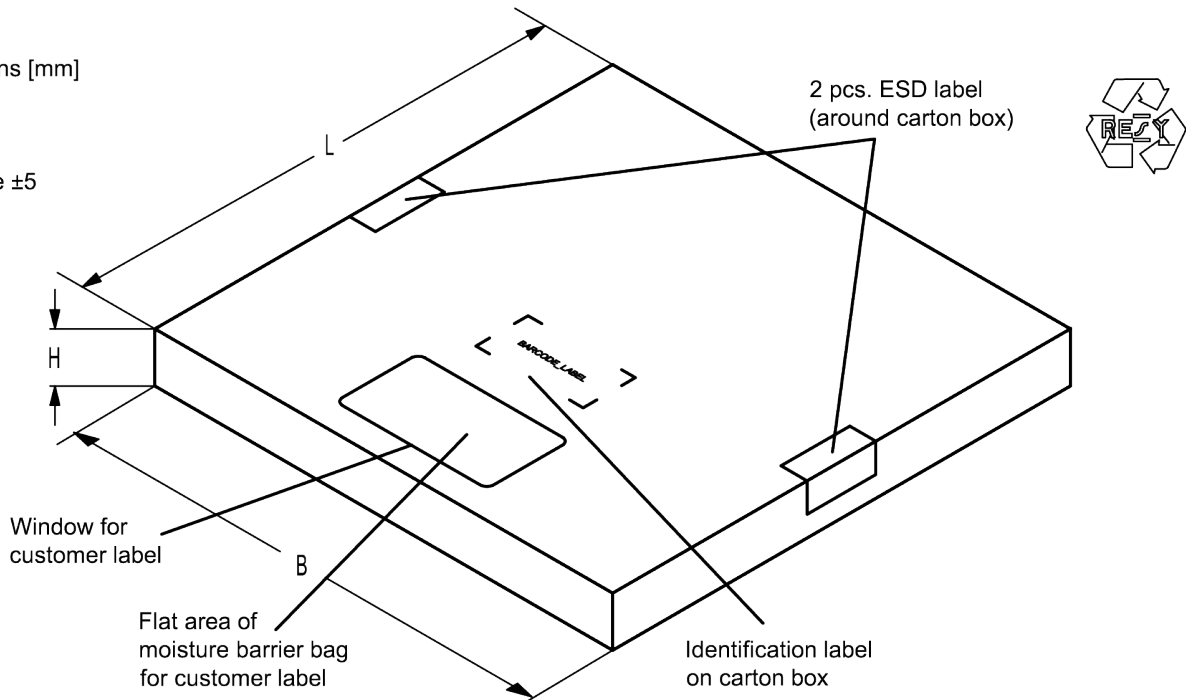


Figure 13: Drawing of folding box for reel with diameter of 180 mm.

SAW components	B4421
SAW duplexer	1747.5 / 1842.5 MHz

Data sheet

11 Marking

Products are marked with product type number and lot number encoded according to Table 2:

■ Type number:

The 4 digit type number of the ordering code, e.g., B3xxxxB**1234**xxxx,
is encoded by a special BASE32 code into a 3 digit marking.

Example of decoding	type number marking on device	in decimal code.
	16J	1234
	$1 \times 32^2 + 6 \times 32^1 + 18 (=J) \times 32^0$	1234

The BASE32 code for product type B4421 is 4A5.

■ Lot number:

The last 5 digits of the lot number, e.g., **12345**,
are encoded based on a special BASE47 code into a 3 digit marking.

Example of decoding lot number marking on device		in decimal code.
	5UY	12345
	$5 \times 47^2 + 27 (=U) \times 47^1 + 31 (=Y) \times 47^0$	12345

Adopted BASE32 code for type number			
Decimal value	Base32 code	Decimal value	Base32 code
0	0	16	G
1	1	17	H
2	2	18	J
3	3	19	K
4	4	20	M
5	5	21	N
6	6	22	P
7	7	23	Q
8	8	24	R
9	9	25	S
10	A	26	T
11	B	27	V
12	C	28	W
13	D	29	X
14	E	30	Y
15	F	31	Z

Adopted BASE47 code for lot number			
Decimal value	Base47 code	Decimal value	Base47 code
0	0	24	R
1	1	25	S
2	2	26	T
3	3	27	U
4	4	28	V
5	5	29	W
6	6	30	X
7	7	31	Y
8	8	32	Z
9	9	33	b
10	A	34	d
11	B	35	f
12	C	36	h
13	D	37	n
14	E	38	r
15	F	39	t
16	G	40	v
17	H	41	\
18	J	42	?
19	K	43	{
20	L	44	}
21	M	45	<
22	N	46	>
23	P		

Table 2: Lists for encoding and decoding of marking.

Data sheet

12 Soldering profile

The recommended soldering process is in accordance with IEC 60068-2-58 – 3rd edit and IPC/JEDEC J-STD-020B.

ramp rate	≤ 3 K/s
preheat	125 °C to 220 °C, 150 s to 210 s, 0.4 K/s to 1.0 K/s
$T > 220$ °C	30 s to 70 s
$T > 230$ °C	min. 10 s
$T > 245$ °C	max. 20 s
$T \geq 255$ °C	–
peak temperature T_{peak}	250 °C +0/-5 °C
wetting temperature T_{min}	230 °C +5/-0 °C for 10 s ± 1 s
cooling rate	≤ 3 K/s
soldering temperature T	measured at solder pads

Table 3: Characteristics of recommended soldering profile for lead-free solder (Sn95.5Ag3.8Cu0.7).

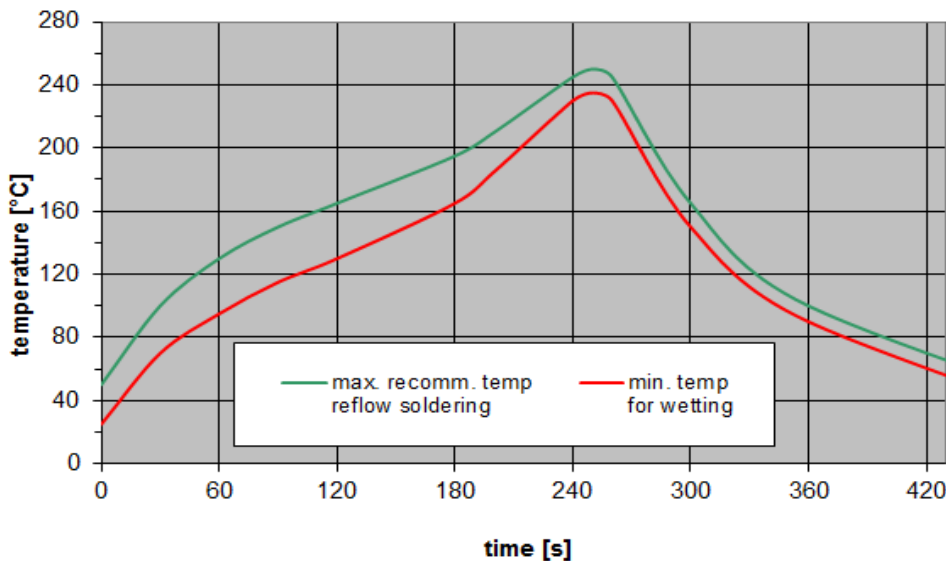


Figure 14: Recommended reflow profile for convection and infrared soldering – lead-free solder.

Data sheet

13 Annotations

13.1 Matching coils

See TDK inductor pdf-catalog <http://www.tdk.co.jp/tefe02/coil.htm#aname1> and Data Library for circuit simulation <http://www.tdk.co.jp/etvcl/index.htm>.

13.2 RoHS compatibility

ROHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.

13.3 Scattering parameters (S-parameters)

The pin/port assignment is available in the headers of the S-parameter files. Please contact your local RF360 sales office.

Data sheet

14 Cautions and warnings

14.1 Display of ordering codes for RF360 products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of RF360, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under www.rf360jv.com/orderingcodes.

14.2 Material information

Due to technical requirements components may contain dangerous substances. For information on the type in question please also contact one of our sales offices.

For information on recycling of tapes and reels please contact one of our sales offices.

14.3 Moldability

Before using in overmolding environment, please contact your local RF360 sales office.

14.4 Package information

Landing area

The printed circuit board (PCB) land pattern (landing area) shown is based on RF360 internal development and empirical data and illustrated for example purposes, only. As customers' SMD assembly processes may have a plenty of variants and influence factors which are not under control or knowledge of RF360, additional careful process development on customer side is necessary and strongly recommended in order to achieve best soldering results tailored to the particular customer needs.

Dimensions

Unless otherwise specified all dimensions are understood using unit millimeter (mm).

Dimensions do not include burrs.

Projection method

Unless otherwise specified first-angle projection is applied.

Important notes

The following applies to all products named in this publication:

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